MOSFET - N-Channel Shielded Gate PowerTrench[®]

150 V, 15 mΩ, 61.3 A

NVDS015N15MC

Features

- Shielded Gate MOSFET Technology
- Max $R_{DS(on)} = 15 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 29 \text{ A}$
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Primary Side for 48 V Isolated Bus
- SR for MV Secondary Applications

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	150	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain Current $R_{\theta JC}$ (Note 2)	Steady State	$T_{C} = 25^{\circ}C$	۱ _D	61.3	А
		T _C = 100°C		43.4	
Power Dissipation $R_{\theta JC}$ (Note 2)		T _C = 25°C	PD	107.1	W
		T _C = 100°C		53.6	
Continuous Drain	Steady State	T _A = 25°C	I _D	10.5	А
Current R _{θJA} (Notes 1, 2)		T _A = 100°C		7.4	
Power Dissipation		T _A = 25°C	PD	3.1	W
$R_{\theta JA}$ (Notes 1, 2)		$T_A = 100^{\circ}C$		1.6	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	382	А
Operating Junction and Storage Temperature Range		T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)		۱ _S	89.3	А	
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 4.4 A)		E _{AS}	1301	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

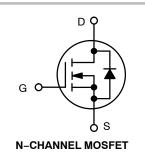
The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

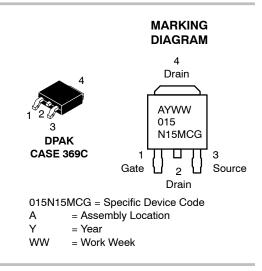


ON Semiconductor®

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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
150 V	15 mΩ @ 10 V	61.3 A





ORDERING INFORMATION

Device	Package	Shipping [†]
NVDS015N15MCT4G	DPAK (Pb-Free)	2500 / Tube

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

THERMAL RESISTANCE MAXIMUM RATINGS

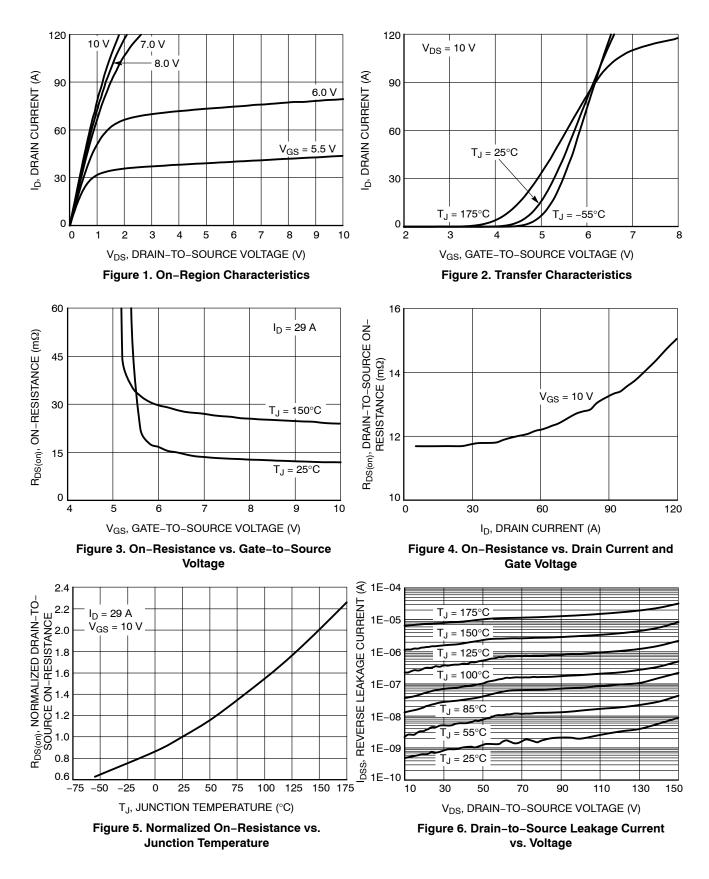
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2)	$R_{ ext{ heta}JC}$	1.4	°C/W
Junction-to-Ambient - Steady State (Notes 1, 2)	$R_{ hetaJA}$	47.9	

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

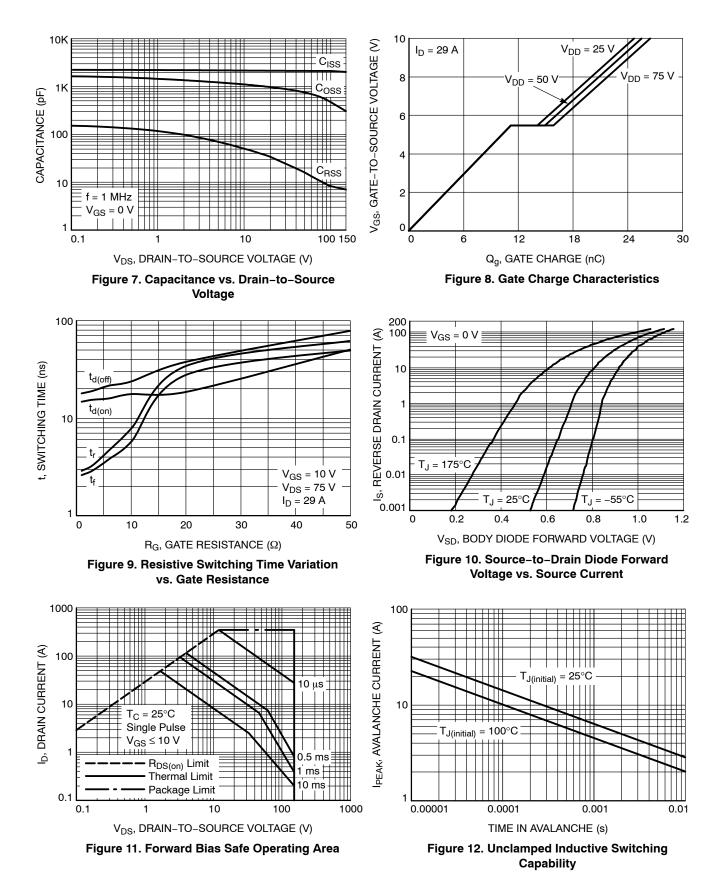
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		150			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	$I_D = 250 \ \mu\text{A}, \text{ ref to } 25^\circ\text{C}$			83		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 120 V	$T_J = 25^{\circ}C$			1.0	
			T _J = 125°C		1.1		μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20 V				±100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D =$	= 162 μA	2.5		4.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J	I _D = 162 μA, ref to 25°C			-8.2		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 29 A			11.8	15	mΩ
Forward Transconductance	9FS	V _{DS} = 10 V, I _D = 29 A			58		S
CHARGES, CAPACITANCES & GATE RESIS	TANCE			-	-	-	
Input Capacitance	C _{ISS}			2120		pF	
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 75 V			595		
Reverse Transfer Capacitance	C _{RSS}				10.5		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 75 V; I _D = 29 A			27		nC
Threshold Gate Charge	Q _{G(TH)}				7		
Gate-to-Source Charge	Q _{GS}				11		
Gate-to-Drain Charge	Q _{GD}				4		
Plateau Voltage	V _{GP}				5.5		V
SWITCHING CHARACTERISTICS (Note 3)		•					
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DD} = 75 V, I _D = 29 A, R _G = 6 Ω			16		- ns
Rise Time	t _r				5		
Turn-Off Delay Time	t _{d(OFF)}				21		
Fall Time	t _f				4		
DRAIN-SOURCE DIODE CHARACTERISTIC	s	-		-	-	-	-
Forward Diode Voltage	V _{SD}	V_{GS} = 0 V, I _S = 29 A	$T_J = 25^{\circ}C$		0.89	1.2	V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, V _{DD} = 75 V dI _S /dt = 300 A/μs, I _S = 29 A			49		ns
Reverse Recovery Charge	Q _{RR}				197		nC
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, V_{DD} = 75 V dI _S /dt = 1000 A/µs, I _S = 29 A			34		ns
Reverse Recovery Charge	Q _{RR}				345		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.3. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



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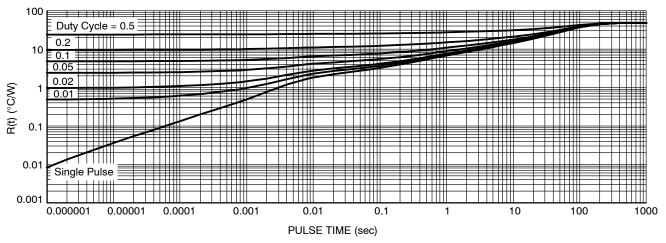
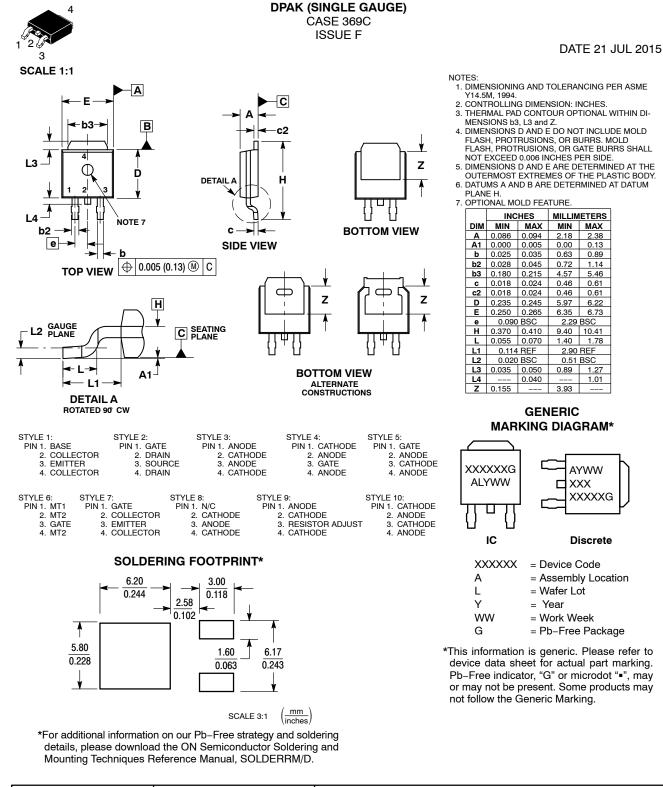


Figure 13. Transient Thermal Impedance



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